

# Octal D-type flip-flop with 5-volt tolerant inputs/outputs; positive edge-triggered (3-State)

74LVC374A

## FEATURES

- 5-volt tolerant inputs/outputs, for interfacing with 5-volt logic
- Supply voltage range of 2.7V to 3.6V
- Complies with JEDEC standard no. 8-1A
- CMOS low power consumption
- Direct interface with TTL levels
- High impedance when  $V_{CC} = 0V$
- 8-bit positive edge-triggered register
- Independent register and 3-State buffer operation

## DESCRIPTION

The 74LVC374A is a high-performance, low-power, low-voltage, Si-gate CMOS device, superior to most advanced CMOS compatible TTL families.

## QUICK REFERENCE DATA

$GND = 0V$ ;  $T_{amb} = 25^\circ C$ ;  $t_r = t_f \leq 2.5\text{ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
$t_{PHL}/t_{PLH}$	Propagation delay CP to $Q_n$	$C_L = 50\text{pF}$ $V_{CC} = 3.3V$	4.8	ns
$f_{max}$	maximum clock frequency		150	MHz
$C_I$	Input capacitance		5.0	pF
$C_{PD}$	Power dissipation capacitance per flip-flop	Notes 1 and 2	20	pF

### NOTE:

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;  $C_L$  = output load capacity in pF;

$f_o$  = output frequency in MHz;  $V_{CC}$  = supply voltage in V;

$\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

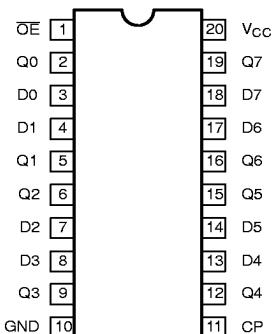
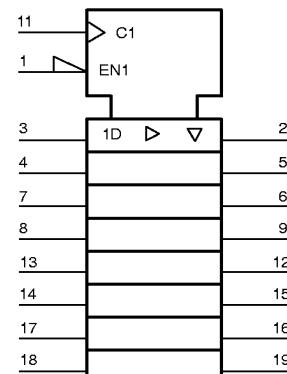
2. The condition is  $V_I = GND$  to  $V_{CC}$

## ORDERING INFORMATION

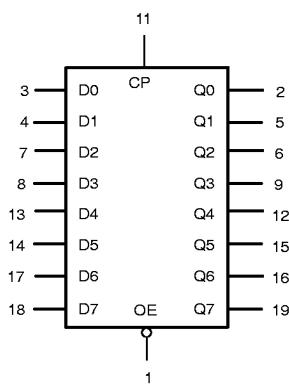
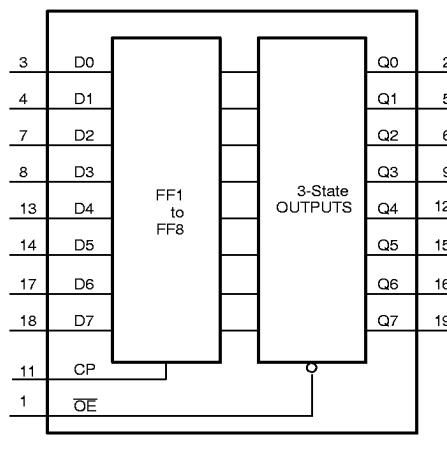
PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
20-Pin Plastic Shrink Small Outline (SO)	-40°C to +85°C	74LVC374A D	74LVC374A D	SOT163-1
20-Pin Plastic Shrink Small Outline (SSOP) Type II	-40°C to +85°C	74LVC374A DB	74LVC374A DB	SOT339-1
20-Pin Plastic Thin Shrink Small Outline (TSSOP) Type I	-40°C to +85°C	74LVC374A PW	7LVC374APW DH	SOT360-1

# Octal D-type flip-flop with 5-volt tolerant inputs/outputs; positive edge-triggered (3-State)

74LVC374A

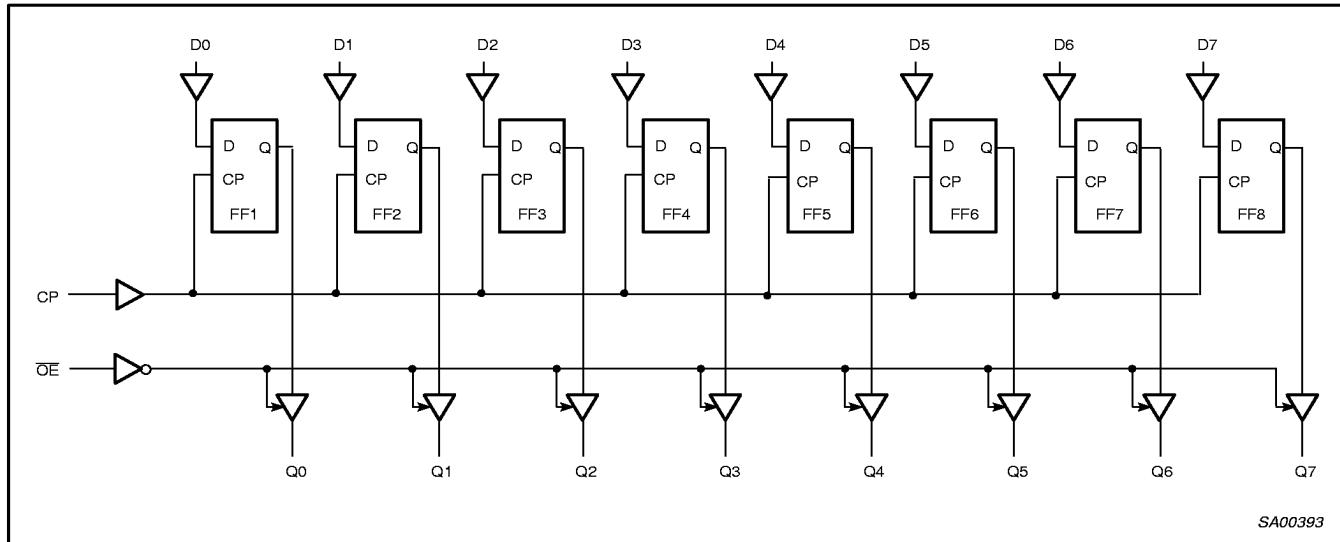
**PIN CONFIGURATION****LOGIC SYMBOL (IEEE/IEC)****PIN DESCRIPTION**

PIN NUMBER	SYMBOL	FUNCTION
1	$\overline{OE}$	Output enable input (active-Low)
3, 4, 7, 8, 13, 14, 17, 18	D0-D7	Data inputs
2, 5, 6, 9, 12, 15, 16, 19	Q0-Q7	3-state flip-flop outputs
11	CP	Clock input (LOW-to-HIGH, edge-triggered)
10	GND	Ground (0V)
20	V <sub>CC</sub>	Positive supply voltage

**LOGIC SYMBOL****FUNCTIONAL DIAGRAM**

# Octal D-type flip-flop with 5-volt tolerant inputs/outputs; positive edge-trigger (3-State)

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**LOGIC DIAGRAM****FUNCTION TABLE**

OPERATING MODES	INPUTS			INTERNAL FLIP-FLOPS	OUTPUTS $Q_0$ to $Q_7$
	$\overline{OE}$	LE	$D_n$		
Load and read register	L L	↑ ↑	I h	L H	L H
Load register and disable outputs	H H	↑ ↑	I h	L H	Z Z

H = HIGH voltage level

h = HIGH voltage level one setup time prior to the LOW-to-HIGH CP transition

L = LOW voltage level

I = LOW voltage level one setup time prior to the LOW-to-HIGH CP transition

Z = High impedance OFF-state

↑ = LOW-to-HIGH clock transition

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## RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIMITS		UNIT
			MIN	MAX	
$V_{CC}$	DC supply voltage (for max. speed performance)		2.7	3.6	V
	DC supply voltage (for low-voltage applications)		1.2	3.6	
$V_I$	DC input voltage range		0	5.5	V
$V_O$	DC output voltage range; output HIGH or LOW state		0	$V_{CC}$	V
	DC output voltage range; output 3-State		0	5.5	
$T_{amb}$	Operating ambient temperature range in free-air		-40	+85	°C
$t_r, t_f$	Input rise and fall times	$V_{CC} = 1.2 \text{ to } 2.7\text{V}$ $V_{CC} = 2.7 \text{ to } 3.6\text{V}$	0 0	20 10	ns/V

## ABSOLUTE MAXIMUM RATINGS<sup>1</sup>

In accordance with the Absolute Maximum Rating System (IEC 134)

Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
$V_{CC}$	DC supply voltage		-0.5 to +6.5	V
$I_{IK}$	DC input diode current	$V_I < 0$	-50	mA
$V_I$	DC input voltage	Note 2	-0.5 to +6.5	V
$I_{OK}$	DC output diode current	$V_O > V_{CC}$ or $V_O < 0$	± 50	mA
$V_O$	DC output voltage; output HIGH or LOW state	Note 2	-0.5 to $V_{CC} + 0.5$	V
	DC output voltage; output 3-State	Note 2	-0.5 to 6.5	
$I_O$	DC output source or sink current	$V_O = 0$ to $V_{CC}$	± 50	mA
$I_{GND}, I_{CC}$	DC $V_{CC}$ or GND current		± 100	mA
$T_{stg}$	Storage temperature range		-65 to +150	°C
$P_{TOT}$	Power dissipation per package – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	500 500	mW

### NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# Octal D-type flip-flop with 5-volt tolerant inputs/outputs; positive edge-trigger (3-State)

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## DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT	
			Temp = -40°C to +85°C				
			MIN	TYP <sup>1</sup>	MAX		
V <sub>IH</sub>	HIGH level Input voltage	V <sub>CC</sub> = 1.2V	V <sub>CC</sub>			V	
		V <sub>CC</sub> = 2.7 to 3.6V	2.0				
V <sub>IL</sub>	LOW level Input voltage	V <sub>CC</sub> = 1.2V			GND	V	
		V <sub>CC</sub> = 2.7 to 3.6V			0.8		
V <sub>OH</sub>	HIGH level output voltage	V <sub>CC</sub> = 2.7V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = -12mA	V <sub>CC</sub> -0.5			V	
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = -100μA	V <sub>CC</sub> -0.2	V <sub>CC</sub>			
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = -18mA	V <sub>CC</sub> -0.6				
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = -24mA	V <sub>CC</sub> -0.8				
V <sub>OL</sub>	LOW level output voltage	V <sub>CC</sub> = 2.7V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 12mA			0.40	V	
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 100μA		GND	0.20		
		V <sub>CC</sub> = 3.0V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; I <sub>O</sub> = 24mA			0.55		
I <sub>I</sub>	Input leakage current <sup>2</sup>	V <sub>CC</sub> = 3.6V; V <sub>I</sub> = 5.5V or GND		±0.1	±5	μA	
I <sub>OZ</sub>	3-State output OFF-state current	V <sub>CC</sub> = 3.6V; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>O</sub> = 5.5V or GND		0.1	±10	μA	
I <sub>off</sub>	Power off leakage supply	V <sub>CC</sub> = 0.0V; V <sub>I</sub> or V <sub>O</sub> = 5.5V		0.1	±10	μA	
I <sub>CC</sub>	Quiescent supply current	V <sub>CC</sub> = 3.6V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0		0.1	10	μA	
ΔI <sub>CC</sub>	Additional quiescent supply current per input pin	V <sub>CC</sub> = 2.7V to 3.6V; V <sub>I</sub> = V <sub>CC</sub> -0.6V; I <sub>O</sub> = 0		5	500	μA	

### NOTES:

- All typical values are at V<sub>CC</sub> = 3.3V and T<sub>amb</sub> = 25°C.
- The specified overdrive current at the data input forces the data input to the opposite logic input state.

## AC CHARACTERISTICS

GND = 0V; t<sub>f</sub> = t<sub>r</sub> ≤ 2.5ns; C<sub>L</sub> = 50pF; R<sub>L</sub> = 500Ω; T<sub>amb</sub> = -40°C to +85°C.

SYMBOL	PARAMETER	WAVEFORM	LIMITS						UNIT
			V <sub>CC</sub> = 3.3V ±0.3V			V <sub>CC</sub> = 2.7V		V <sub>CC</sub> = 1.2V	
			MIN	TYP <sup>1</sup>	MAX	MIN	MAX	TYP	
t <sub>PHL</sub> t <sub>PLH</sub>	Propagation delay CP to Q <sub>n</sub>	1, 4	1.5	4.8	7.0	1.5	8.0	21	ns
t <sub>PZH</sub> t <sub>PZL</sub>	3-State output enable time OE to Q <sub>n</sub>	2, 4	1.5	4.8	7.5	1.5	8.5	22	ns
t <sub>PHZ</sub> t <sub>PLZ</sub>	3-State output disable time OE to Q <sub>n</sub>	2, 4	1.5	4.3	6.0	1.5	7.0	15	ns
t <sub>w</sub>	Clock pulse width HIGH or LOW	1	3.0	1.5	—	3.0	—	—	ns
t <sub>su</sub>	Setup time D <sub>n</sub> to CP	3	2.0	0	—	2.0	—	—	ns
t <sub>h</sub>	Hold time D <sub>n</sub> to CP	3	1.5	0.6	—	1.5	—	—	ns
f <sub>max</sub>	maximum clock pulse frequency	1	100	—	—	80	—	—	MHz

### NOTE:

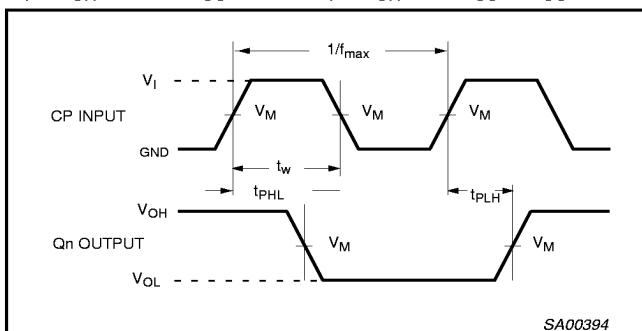
- Unless otherwise stated, all typical values are at V<sub>CC</sub> = 3.3V and T<sub>amb</sub> = 25°C.

# Octal D-type flip-flop with 5-volt tolerant inputs/outputs; positive edge-trigger (3-State)

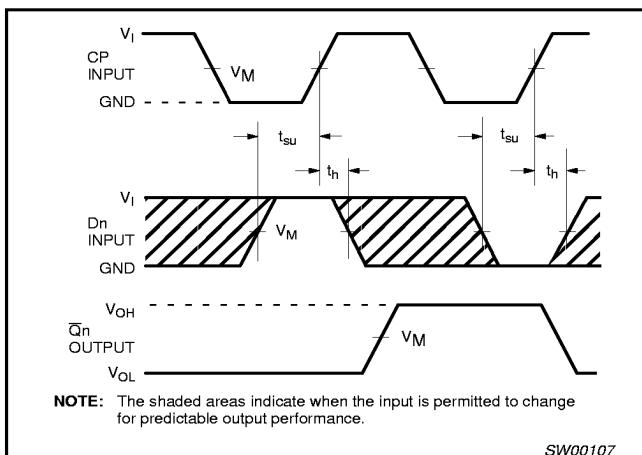
74LVC374A

## AC WAVEFORMS

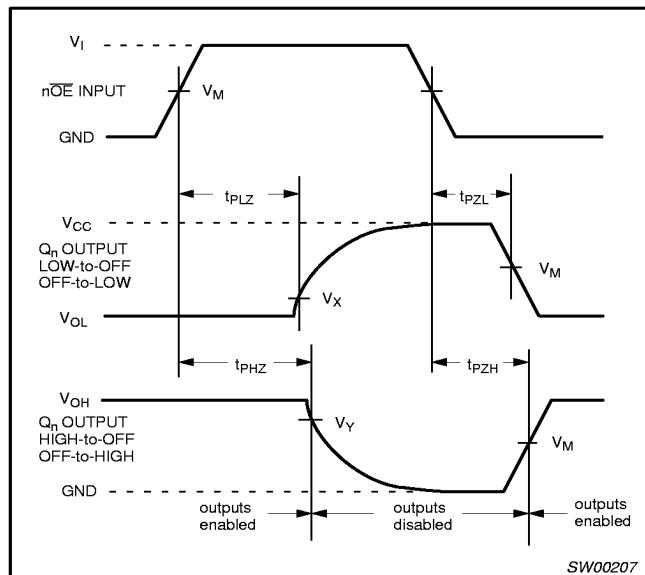
$V_M = 1.5V$  at  $V_{CC} \geq 2.7V$ ;  $V_M = 0.5 V_{CC}$  at  $V_{CC} < 2.7V$ .  
 $V_{OL}$  and  $V_{OH}$  are the typical output voltage drop that occur with the output load.  
 $V_X = V_{OL} + 0.3V$  at  $V_{CC} \geq 2.7V$ ;  $V_X = V_{OL} + 0.1 V_{CC}$  at  $V_{CC} < 2.7V$   
 $V_Y = V_{OH} - 0.3V$  at  $V_{CC} \geq 2.7V$ ;  $V_Y = V_{OH} - 0.1 V_{CC}$  at  $V_{CC} < 2.7V$



Waveform 1. Clock (CP) to output ( $Q_n$ ) propagation delays, the clock pulse width, output transition times and the maximum clock pulse frequency.

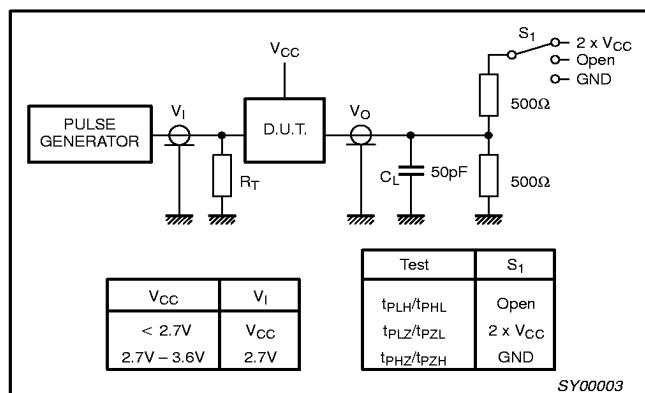


Waveform 2. Data setup and hold times for the  $D_n$  input to the CP input.



Waveform 3. 3-State enable and disable times.

## TEST CIRCUIT



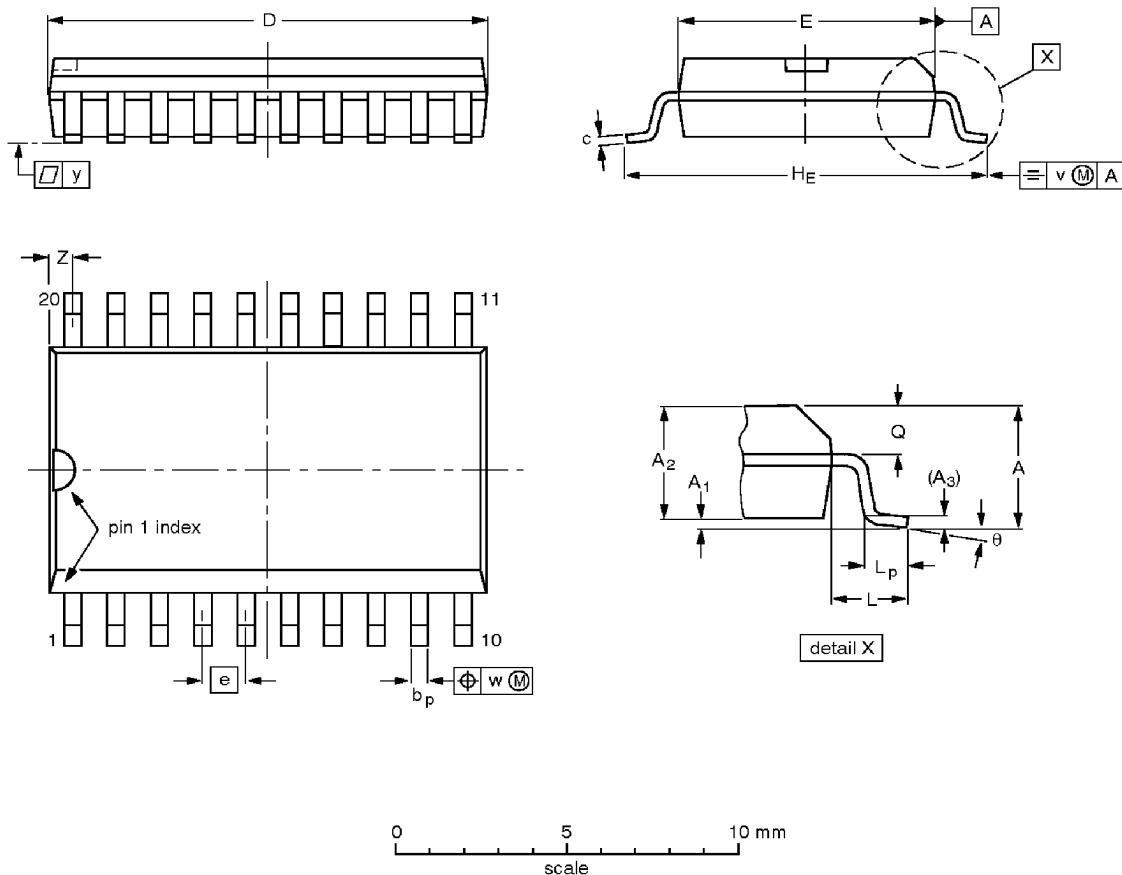
Waveform 4. Load circuitry for switching times.

# Octal D-type flip-flop with 5-volt tolerant inputs/outputs; positive edge-trigger (3-State)

74LVC374A

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1

**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	z <sup>(1)</sup>	θ
mm	2.65 0.10	0.30 2.45 0.25	2.45 2.25	0.25	0.49 0.36	0.32 0.23	13.0 12.6	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8° 0°
inches	0.10 0.004	0.012 0.089	0.096	0.01	0.019 0.014	0.013 0.009	0.51 0.49	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	

**Note**

- Plastic or metal protrusions of 0.15 mm maximum per side are not included.

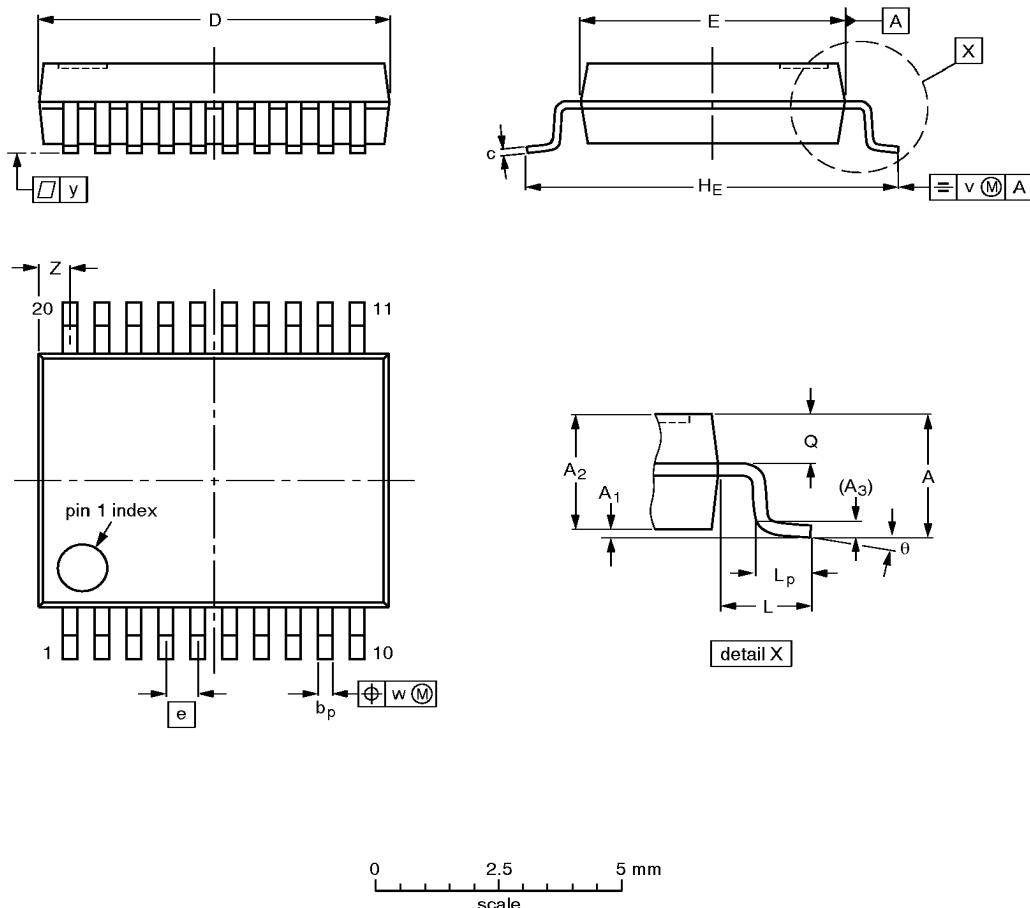
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT163-1	075E04	MS-013AC				-95-01-24 97-05-22

# Octal D-type flip-flop with 5-volt tolerant inputs/outputs; positive edge-trigger (3-State)

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SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1

**DIMENSIONS (mm are the original dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

**Note**

- Plastic or metal protrusions of 0.20 mm maximum per side are not included.

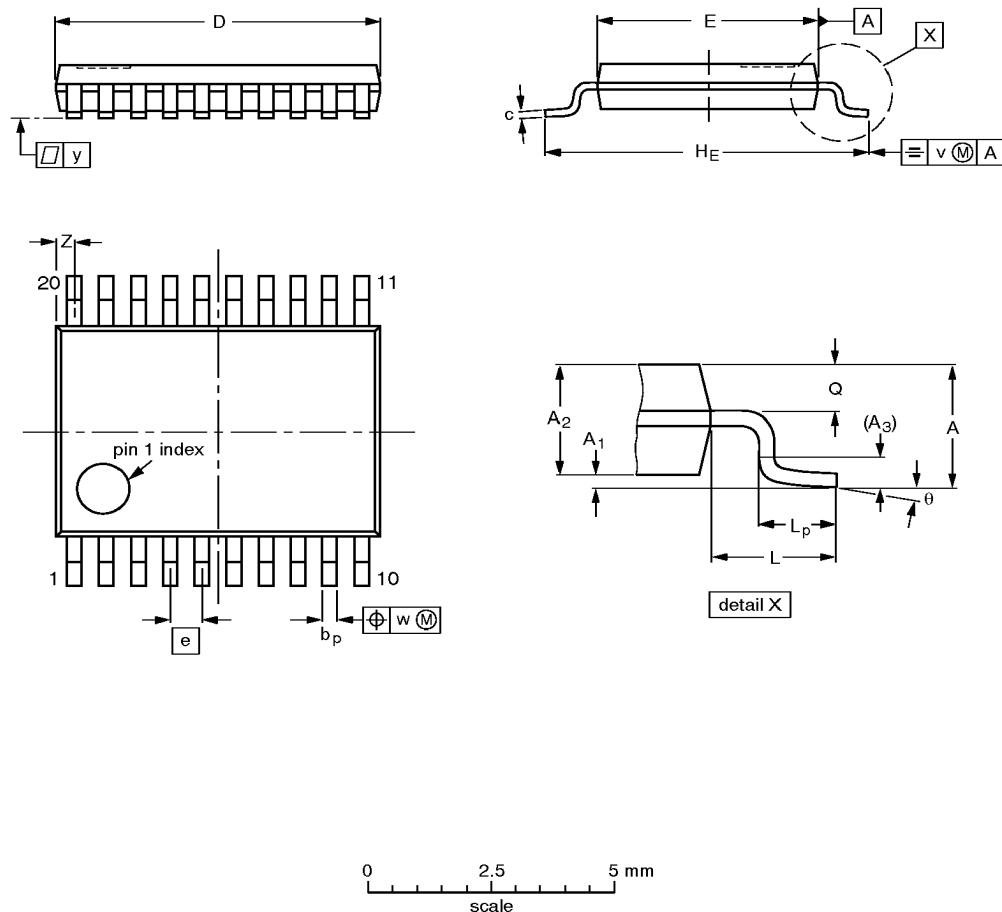
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT339-1		MO-150AE				93-09-08- 95-02-04

# Octal D-type flip-flop with 5-volt tolerant inputs/outputs; positive edge-trigger (3-State)

74LVC374A

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

**DIMENSIONS (mm are the original dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(2)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.10 0.05	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

**Notes**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT360-1		MO-153AC				-93-06-16 95-02-04